

## C1812C393FATAC7210

SMD Comm X8G HT150C, Ceramic, 0.039 uF, 1%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1812, 2.3 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X8G HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	67 mg
Shelf Life	78 Weeks
MSL	1

nensions		Spee
p Size	1812	Capa
	4.5mm +/-0.3mm	Mea
	3.2mm +/-0.3mm	Tole
	1mm +/-0.10mm	Volta
	2.3mm MIN	Diele
	0.6mm +/-0.35mm	Tem
		Tom

## Packaging Specifications

Dim Chir L W T S B

Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	4000

Specifications	
Capacitance	0.039 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	1%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	25.641 GOhms

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